



US00D968359S

(12) **United States Design Patent** (10) **Patent No.:** **US D968,359 S**
De (45) **Date of Patent:** **** Nov. 1, 2022**

(54) **HEADPHONE**

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(**) Term: **15 Years**

(57) **CLAIM**

I claim the ornamental design for a headphone, as shown and described.

(21) Appl. No.: **29/770,087**

DESCRIPTION

(22) Filed: **Feb. 9, 2021**

(30) **Foreign Application Priority Data**

Dec. 14, 2020 (JP) 2020-026812 D

(51) **LOC (13) Cl.** **14-01**

(52) **U.S. Cl.**
USPC **D14/205; D14/206**

(58) **Field of Classification Search**
USPC D14/205, 206; D29/112; 2/209;
381/380, 381, 374, 370
CPC H04R 25/00; H04R 25/02; H04R 19/04;
H04R 1/1008; H04R 5/04; H04R 1/1041;
H04R 1/1066; H04R 1/1016; H04R
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See application file for complete search history.

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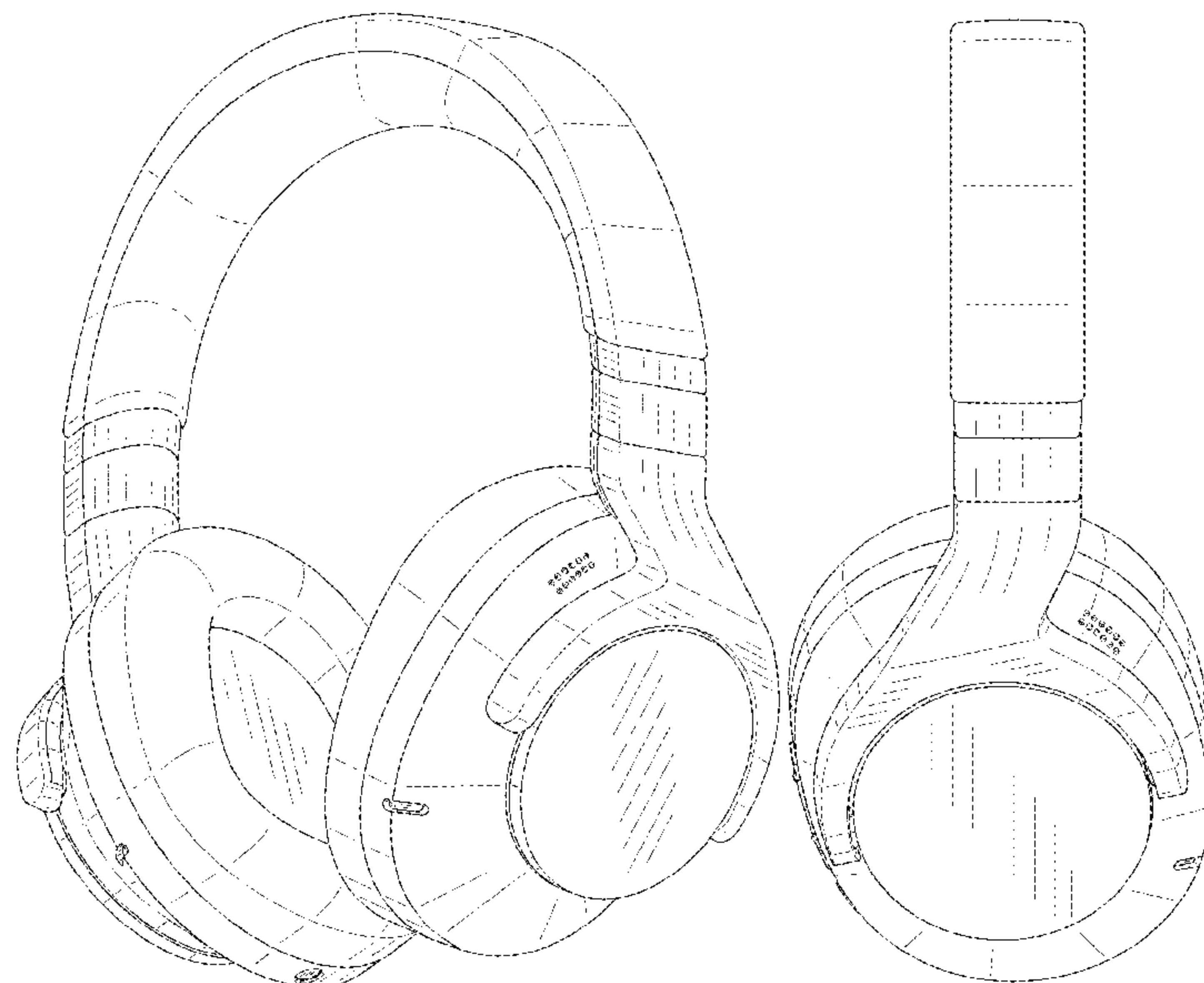
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FIG. 1 is a front perspective view of a headphone according to a first embodiment of the present invention;
FIG. 2 is a front view thereof;
FIG. 3 is a rear view thereof;
FIG. 4 is a first side view thereof;
FIG. 5 is a second side view thereof;
FIG. 6 is a top view thereof;
FIG. 7 is a bottom view thereof;
FIG. 8 is a front perspective view of a headphone according to a second embodiment of the present invention;
FIG. 9 is a front view thereof;
FIG. 10 is a rear view thereof;
FIG. 11 is a first side view thereof;
FIG. 12 is a second side view thereof;
FIG. 13 is a top view thereof;
FIG. 14 is a bottom view thereof;
FIG. 15 is a front perspective view of a headphone according to a third embodiment of the present invention;
FIG. 16 is a front view thereof;
FIG. 17 is a rear view thereof;
FIG. 18 is a first side view thereof;
FIG. 19 is a second side view thereof;
FIG. 20 is a top view thereof; and,
FIG. 21 is a bottom view thereof.

1 Claim, 21 Drawing Sheets



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FIG. 1



FIG. 2



FIG. 3



FIG. 4

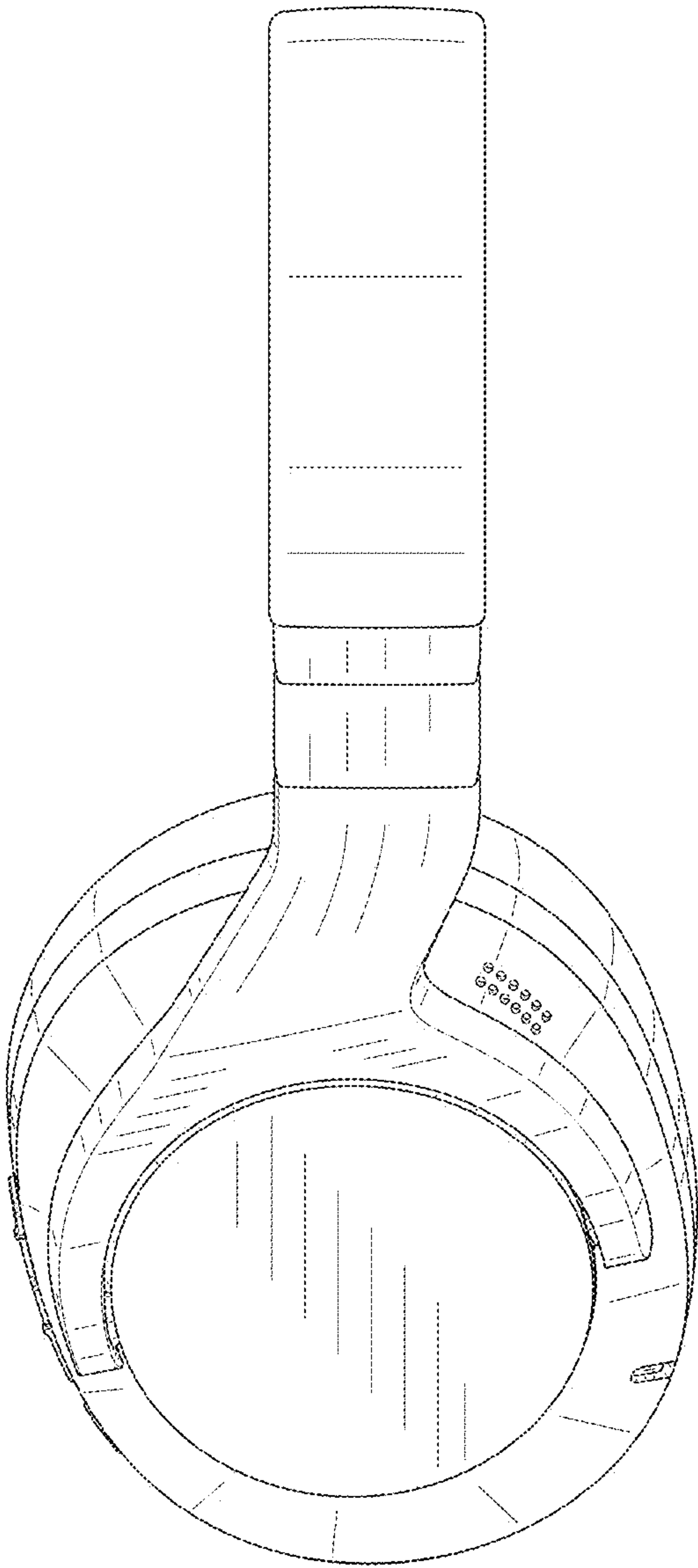


FIG. 5

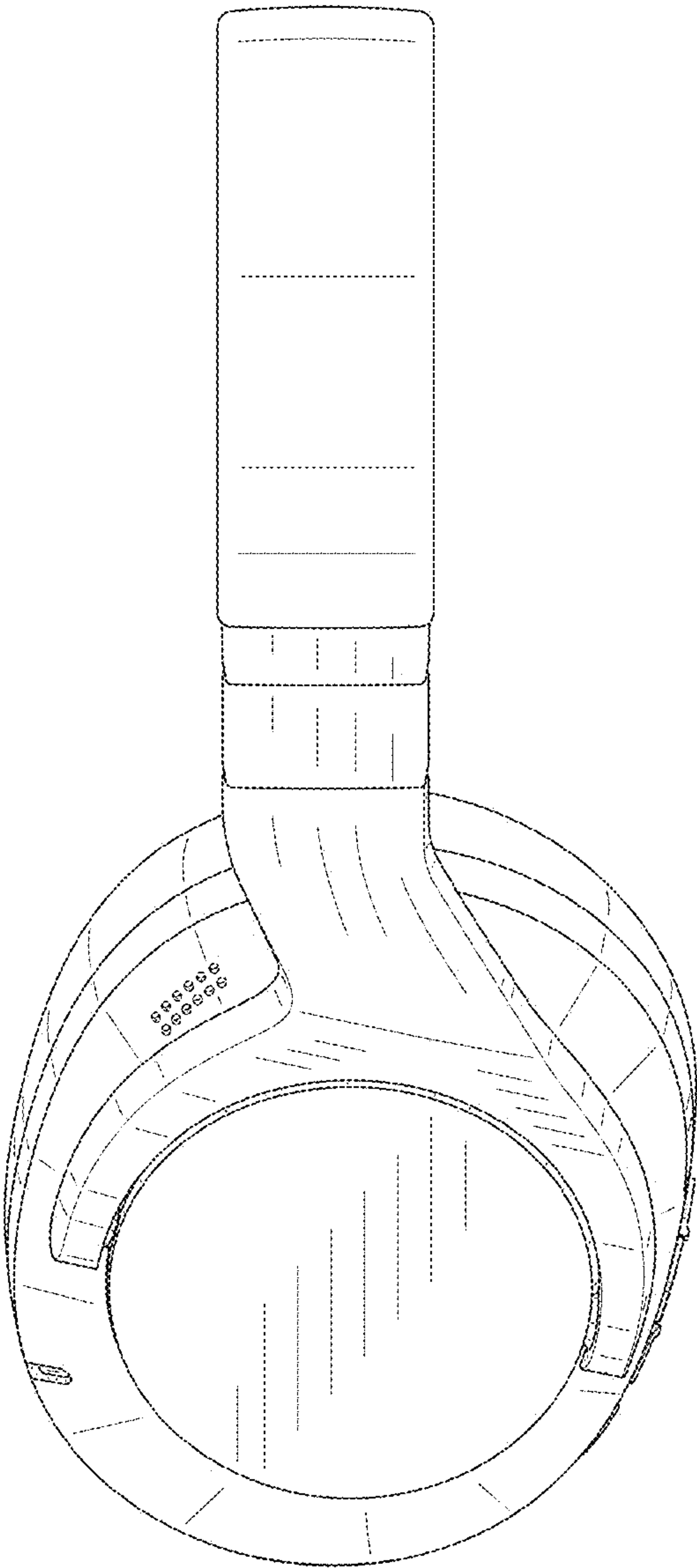


FIG. 6

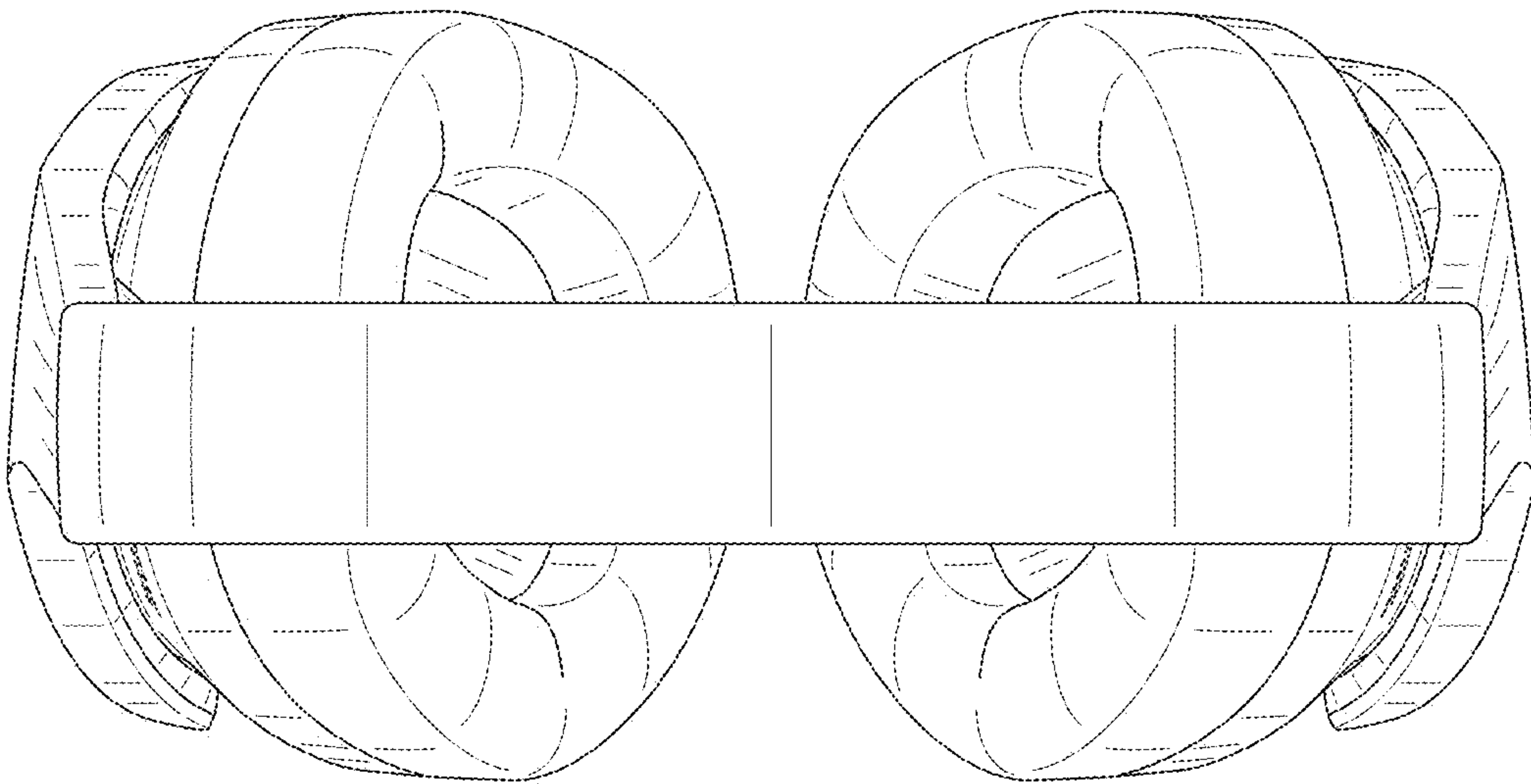


FIG. 7

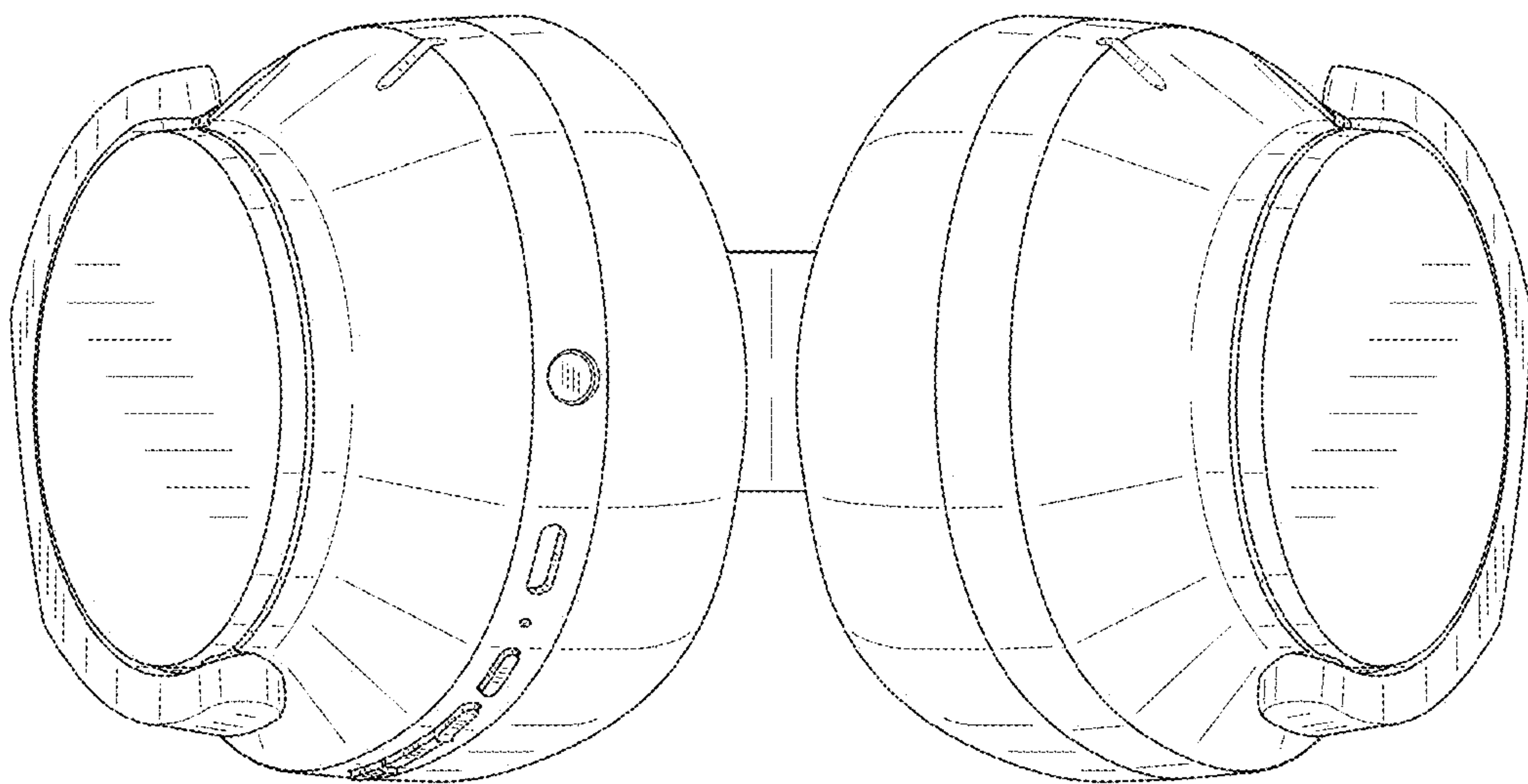


FIG. 8



FIG. 9



FIG. 10



FIG. 11

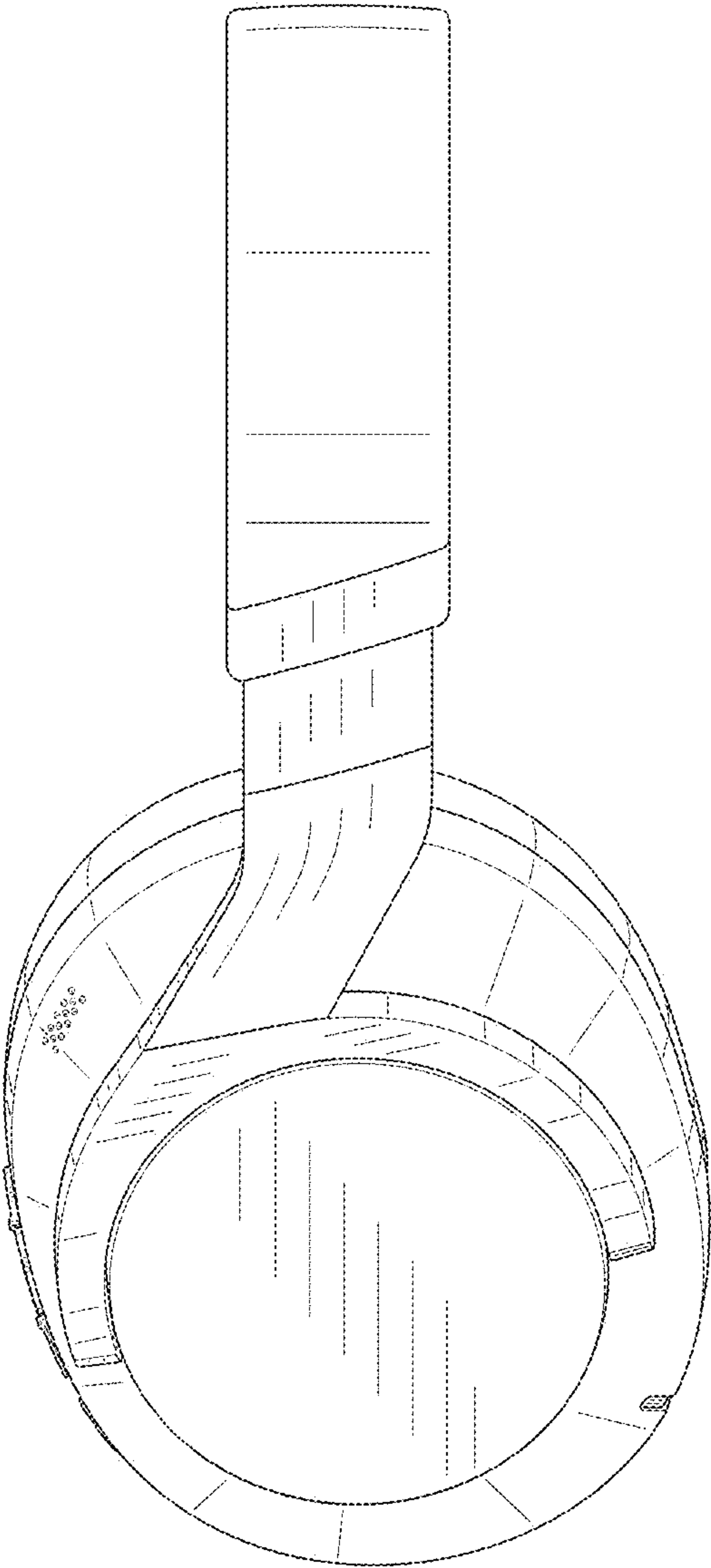


FIG. 12

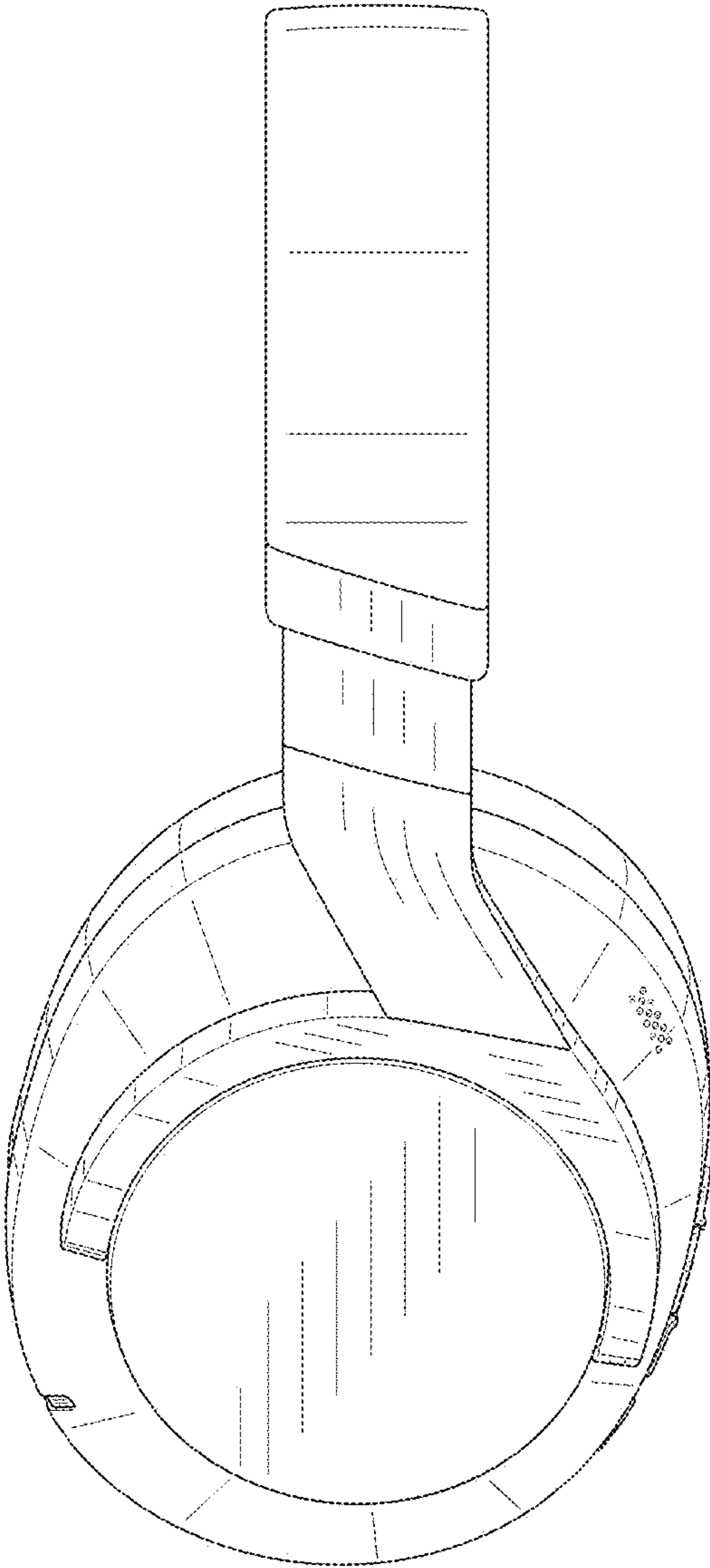


FIG. 13

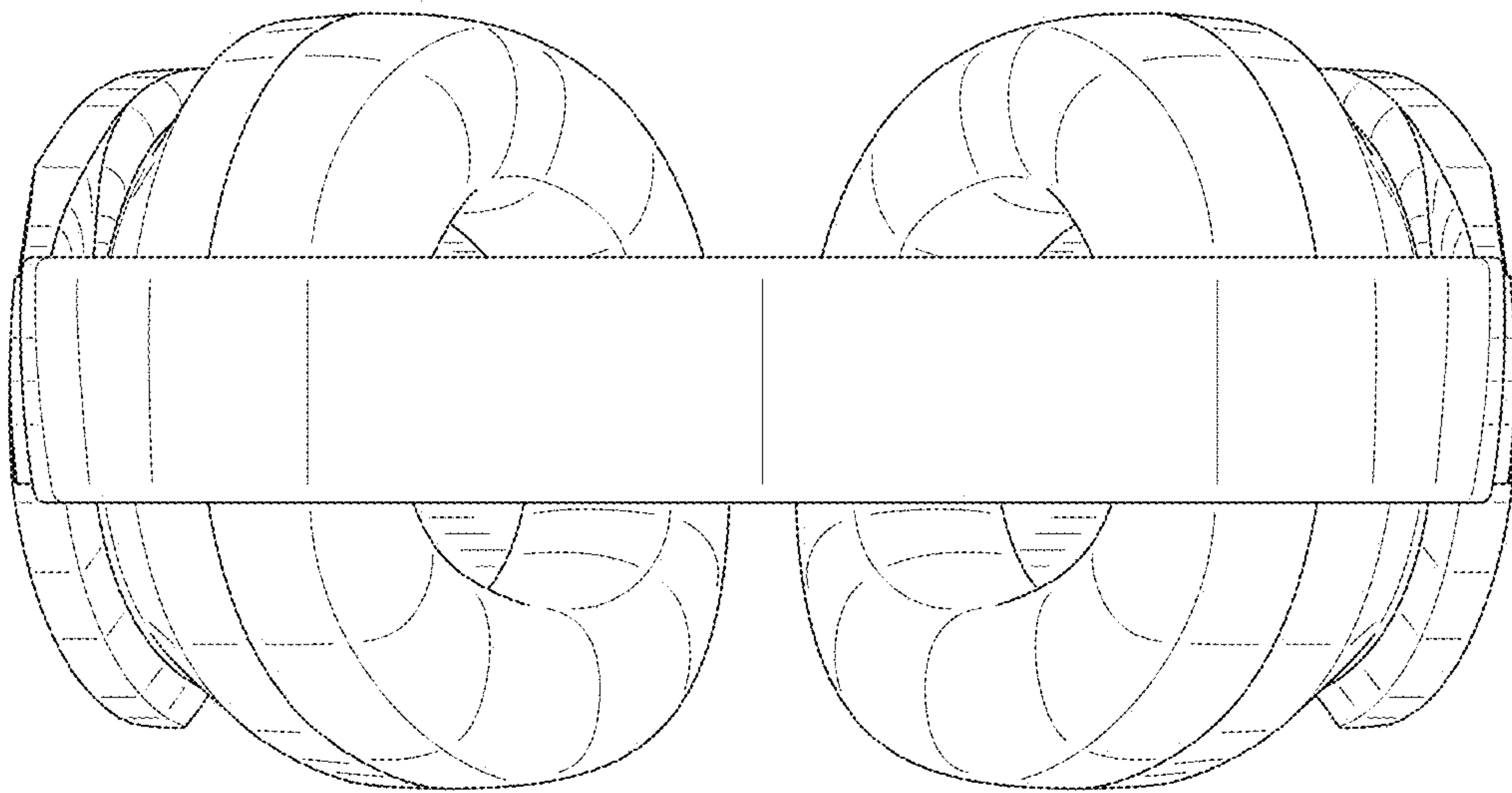


FIG. 14

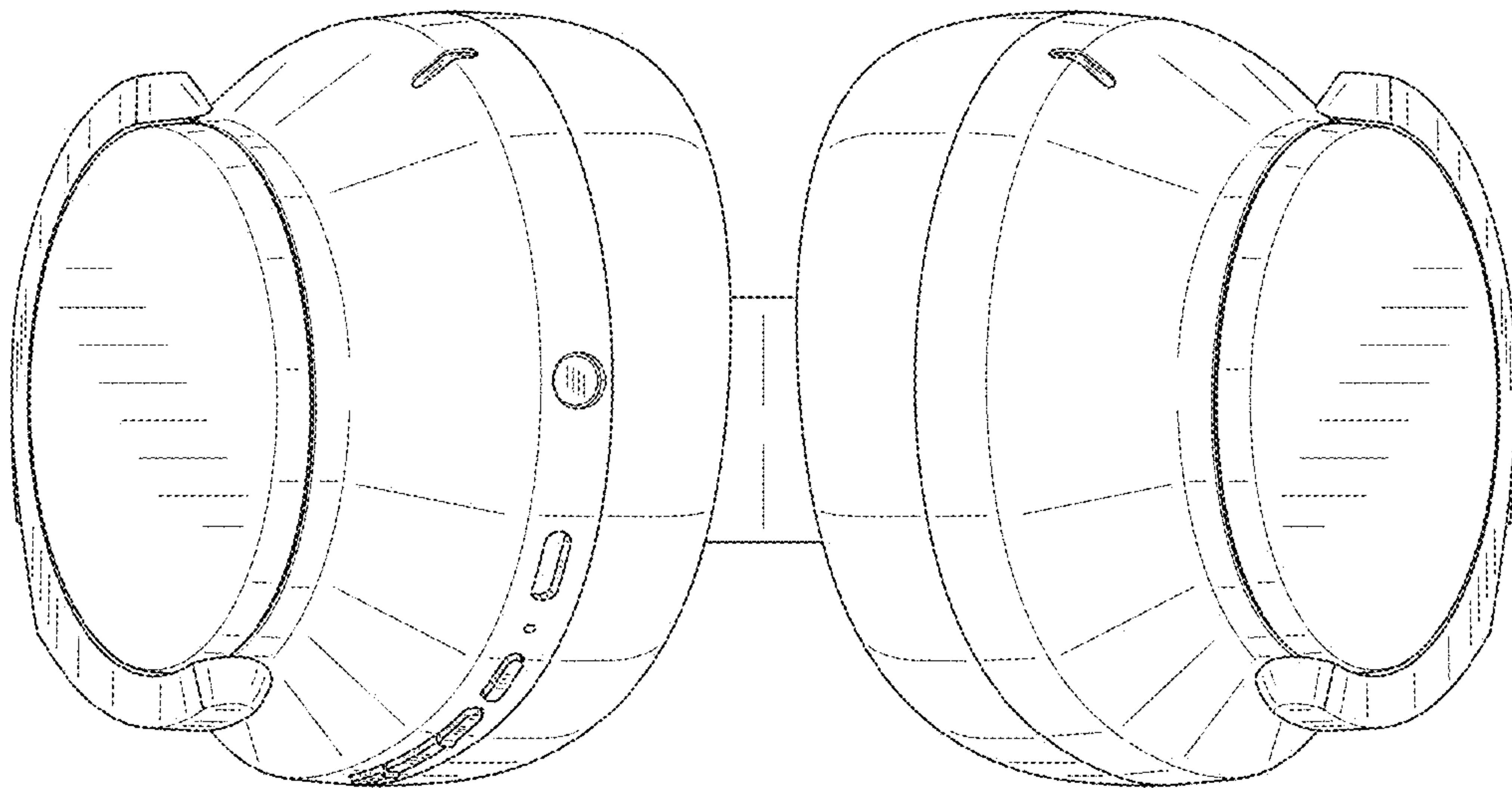


FIG. 15



FIG. 16



FIG. 17



FIG. 18

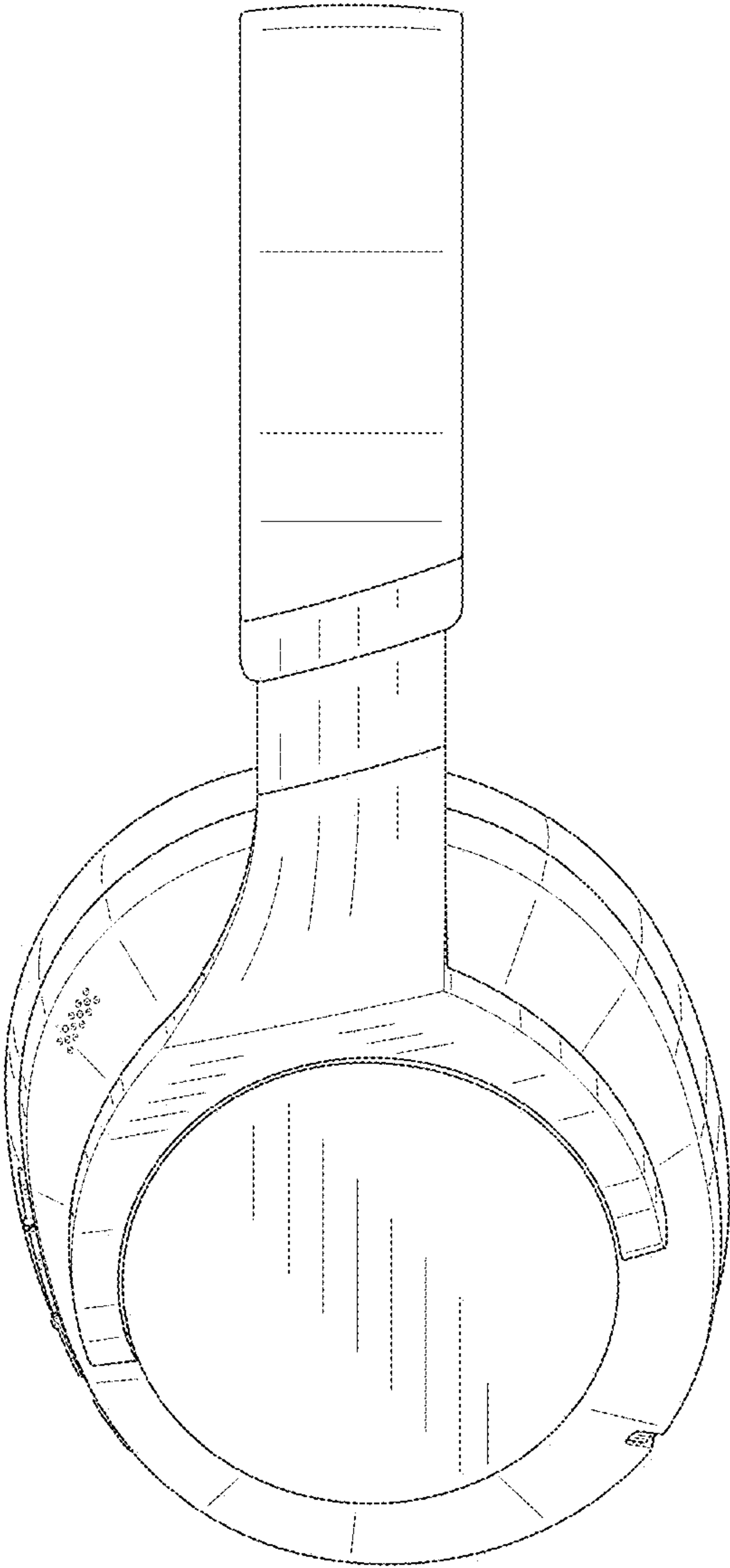


FIG. 19

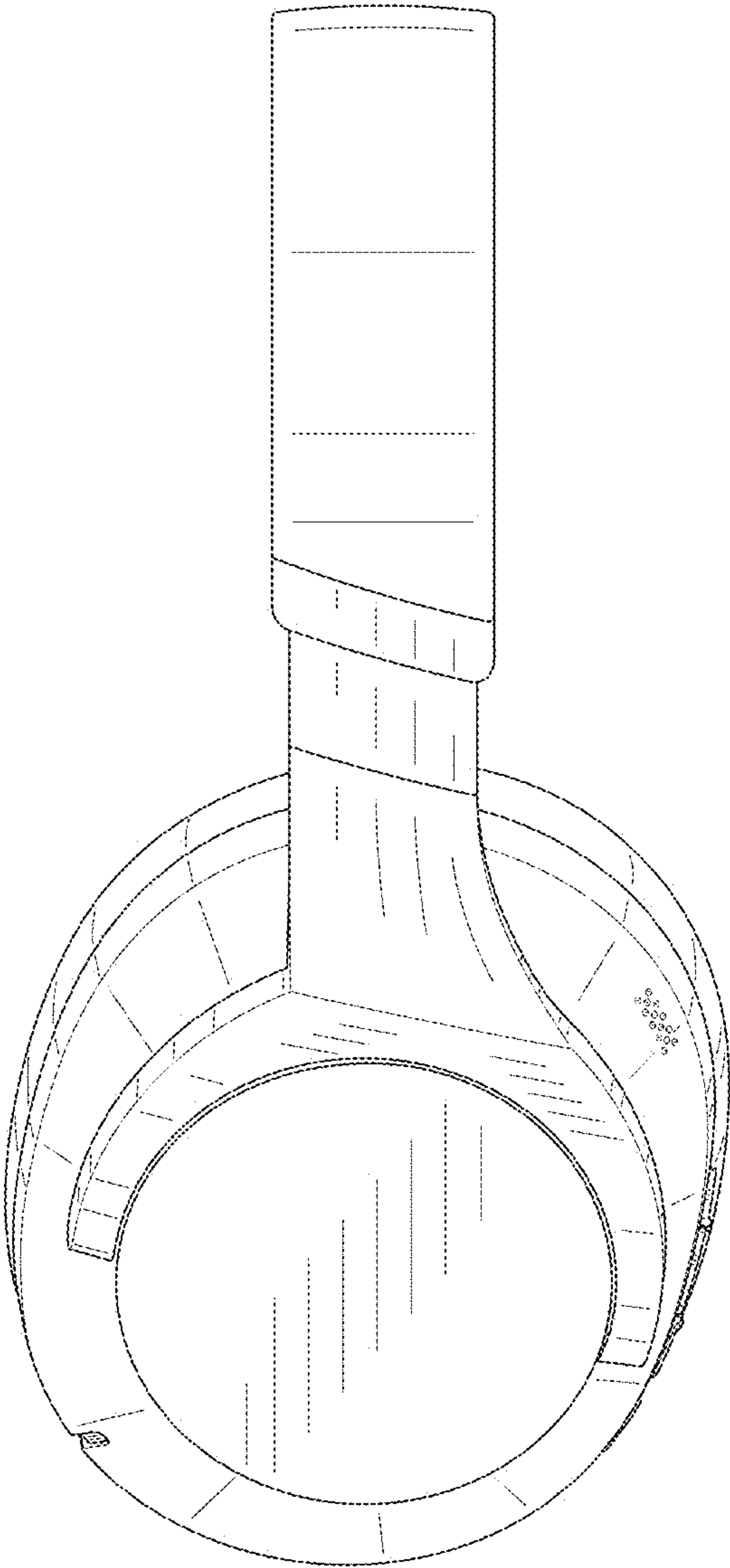


FIG. 20

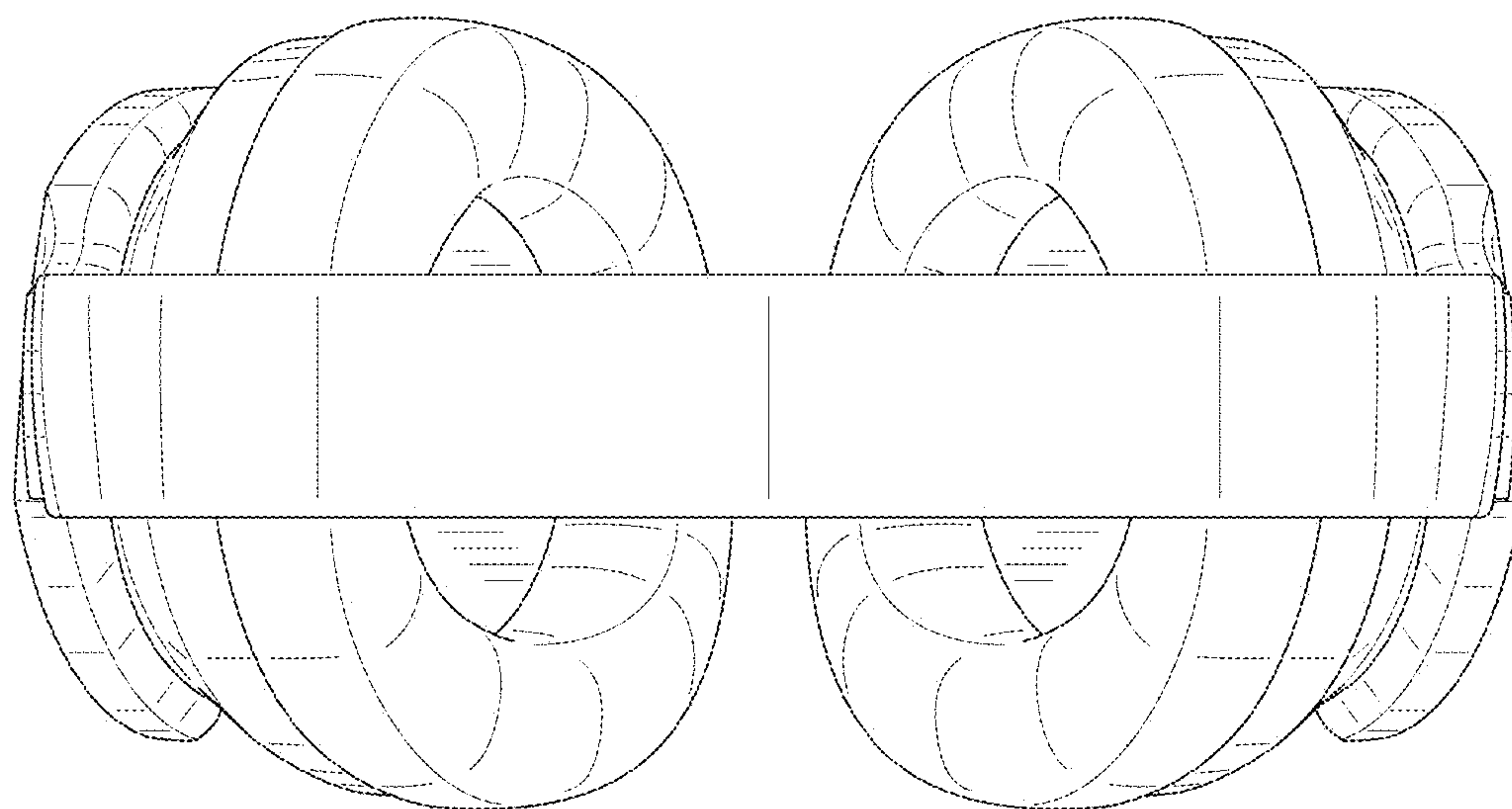


FIG. 21

